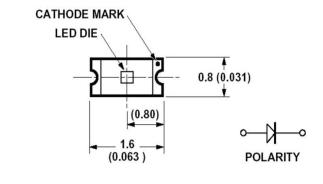
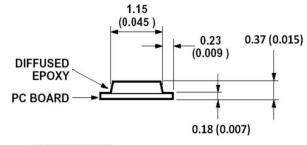
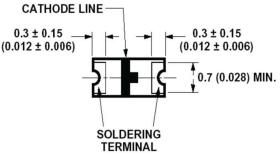
# **Package Dimensions**







#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise specified.

## **Device Selection Guide**

Part Number	Color	Die Technology	Parts per Reel	Package Description
HSMA-C130	Amber	AllnGaP	4000	Untinted, Diffused
HSMC-C130	Red	AllnGaP	4000	Untinted, Diffused
HSME-C130	Yellow Green	AllnGaP	4000	Untinted, Diffused
HSML-C130	Orange	AllnGaP	4000	Untinted, Diffused

# Absolute Maximum Ratings at T<sub>A</sub> = 25°C

Parameter	AlinGaP	Units
DC Forward Current <sup>a</sup>	20	mA
Power Dissipation	48	mW
Reverse Voltage (I <sub>R</sub> = 100 μA)	5	V
LED Junction Temperature	95	°C
Operating Temperature Range	–40°C to +85 °C	
Storage Temperature Range	–40°C to +85 °C	
Soldering Temperature	See reflow soldering profile (Figure 5 and 6)	

a. Derate linearly as shown in Figure 4.

# Electrical Characteristics at T<sub>A</sub> = 25°C

Part Number	_	/ <sub>F</sub> (Volts) @ I <sub>F</sub> = 20 mA	Reverse Breakdown V <sub>R</sub> (Volts) @ I <sub>R</sub> = 100 μA <sup>a</sup> Min.	Thermal Resistance Rθ <sub>JP</sub> (°C/W) Typical
Part Number	Тур.	IVIAX.	IVIIII.	турісаі
HSMA-C130	2.05	2.40	5	500
HSMC-C130	1.94	2.40	5	500
HSME-C130	1.94	2.40	5	500
HSML-C130	1.94	2.40	5	500

a. Indicate product final test condition only, Long-term reverse bias is not recommended.

# Optical Characteristics at T<sub>A</sub> = 25°C

	Luminous Intensity	/ I <sub>V</sub> <sup>a</sup> (mcd) @ 20 mA	Peak Wavelength	Color, Dominant Wavelength $\lambda_d^b$ (nm)	Viewing Angle 2θ <sub>1/2</sub> <sup>c</sup> (Degrees)
Part Number	Min.	Тур.	λpeak (nm) Typical	Typical	Typical
HSMA-C130	28.5	87.0	591	589	110
HSMC-C130	28.5	131.0	635	626	110
HSME-C130	18.0	54.0	575	573	110
HSML-C130	28.5	139.0	612	606	110

a. The luminous intensity I<sub>V</sub> is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.

b. The dominant wavelength,  $\lambda_d$  is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

c.  $\,\theta_{1/2}$  is the off-axis angle where the luminous intensity is ½ the peak intensity.

# **Light Intensity (IV) Bin Limits**

	Intensity (mcd)		
Bin ID	Minimum	Maximum	
M	18.00	28.50	
N	28.50	45.00	
Р	45.00	71.50	
Q	71.50	112.50	
R	112.50	180.00	
S	180.0	285.0	
Т	285.0	450.0	
U	450.0	715.0	
V	715.0	1125.0	
W	1125.0	1800.0	
Х	1800.0	2850.0	
Y	2850.0	4500.0	

Tolerance: ±15%

**NOTE:** Bin categories are established for classification of products. Products may not be available in all

categories. Please contact your Broadcom representative for information on current available bins.

# **Forward Voltage Limits**

	Forward Voltage (V)	
Bin ID	Minimum	Maximum
1	1.60	1.80
2	1.80	2.00
3	2.00	2.20
4	2.20	2.40

## **AllnGaP Amber Color Bin Limits**

	Dominant Wavelength (nm)		
Bin ID	Minimum Maximum		
Α	582.0	584.5	
В	584.5	587.0	
С	587.0	589.5	
D	589.5	592.0	
E	592.0	594.5	
F	594.5	597.0	

Tolerance: ±1 nm

### **AllnGaP Red Color Bin Limits**

	Dominant Wavelength (nm)	
Bin ID	Minimum	Maximum
_	620.0	635.0

Tolerance: ±1 nm

# AllnGaP Yellow Green Color Bin Limits

	Dominant Wavelength (nm)		
Bin ID	Minimum	Maximum	
Α	561.5	564.5	
В	564.5	567.5	
С	567.5	570.5	
D	570.5	573.5	
E	573.5	576.5	

Tolerance: ±1 nm

# **AllnGaP Orange Color Bin Limits**

	Dominant Wavelength (nm)		
Bin ID	Minimum Maximum		
Α	597.0	600.0	
В	600.0	603.0	
С	603.0	606.0	
D	606.0	609.0	
E	609.0	612.0	
F	612.0	615.0	

Tolerance: ±1 nm

NOTE: Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Broadcom representative for information on current available bins.

Figure 1: Luminous Intensity vs. Forward Current

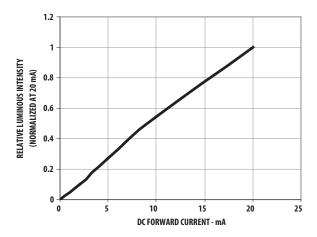


Figure 3: Relative Intensity vs. Peak Wavelength

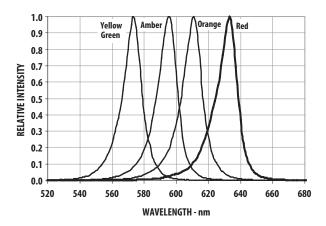


Figure 5: Radiation Pattern

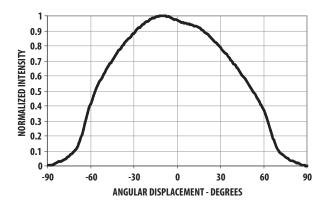


Figure 2: Forward Current vs. Forward Voltage

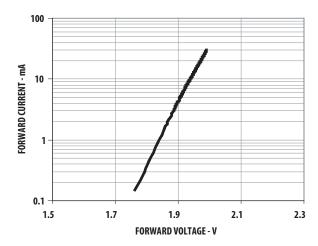


Figure 4: Maximum DC Forward Current vs. Ambient Temperature

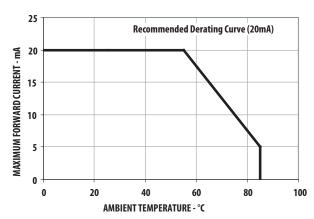
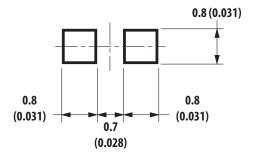


Figure 6: Recommended Soldering Land Pattern



#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1$  mm ( $\pm 0.004$  in.) unless otherwise specified.

Figure 7: Reeling Orientation

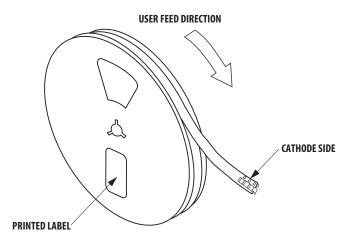


Figure 8: Reel Dimensions

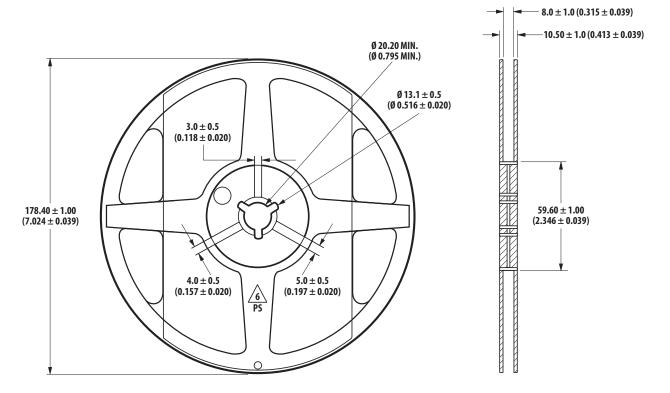
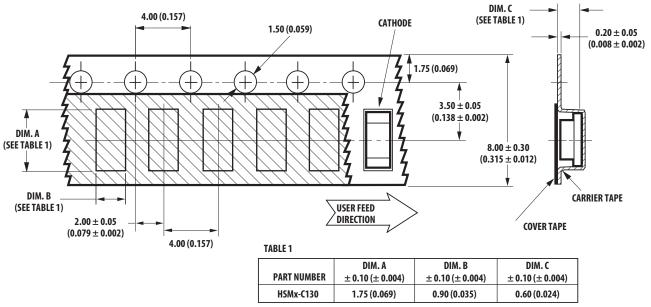


Figure 9: Tape Dimensions



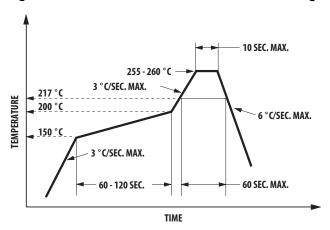
**DIMENSIONS IN MILLIMETERS (INCHES)** 

## **Precautionary Notes**

## **Soldering**

- Do not perform reflow soldering more than twice.
   Observe necessary precautions for handling moisturesensitive devices as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- Use reflow soldering to solder the LED. Use hand soldering only for rework if unavoidable, but it must be strictly controlled to following conditions:
  - Soldering iron tip temperature = 310°C max.
  - Soldering duration = 2s max.
  - Number of cycles = 1 only
  - Power of soldering iron = 50W max.
- Do not touch the LED package body with the soldering iron except for the soldering terminals, because it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED is affected by soldering with hand soldering.

Figure 10: Recommended Lead-Free Reflow Soldering Profile



# **Handling of Moisture-Sensitive Devices**

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices* for additional details and a review of proper handling procedures.

- Before use:
  - An unopened moisture barrier bag (MBB) can be stored at < 40°C/90% RH for 12 months. If the actual indicator card (HIC) indicates that baking is not required, it is safe to reflow the LEDs per the original MSL rating.
  - Do not open the MBB prior to assembly (for example, for IQC). If unavoidable, MBB must be properly resealed with fresh desiccant and HIC. The exposed duration must be taken in as floor life.
- Control after opening the MBB:
  - Read the HIC immediately upon opening of MBB.
  - Keep the LEDs at <30°/60% RH at all times, and complete all high temperature-related processes, including soldering, curing or rework within 672 hours.
- Control for unfinished reel:

Store unused LEDs in a sealed MBB with desiccant or a desiccator at <5% RH.

Control of assembled boards:

If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or desiccator at <5% RH to ensure that all LEDs have not exceeded their floor life of 672 hours.

- Baking is required if:
  - The HIC indicator indicates a change in color for 10% and 5%, as stated on the HIC.
  - The LEDs are exposed to conditions of >30°C/60% RH at any time.
  - The LED's floor life exceeded 672 hours.

The recommended baking condition is:  $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for 20 hours.

Baking can only be done once.

#### **Application Precautions**

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of forward voltage (V<sub>F</sub>) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (meaning: intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- If the LED is intended to be used along with an LED of another color to achieve color mixing, Broadcom does not guarantee the consistency of the resultant color. Contact your Broadcom sales representative for such applications.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Avoid rapid change in ambient temperature, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in harsh or outdoor environments, protect the LED against damages caused by rain water, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

# **Eye Safety Precautions**

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment

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